Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	1351	(257/779).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/08 10:54
L3	218	(257/e23.162).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/08 10:56
L4	2326	(438/614).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/08 10:57
S1	24	(("5611481") or ("3276750") or ("10321671") or ("0766310") or ("2159047") or ("0098046") or ("9213702") or ("9326465") or ("2000243785")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/20 12:45
S2	2	("20040169286").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR .	OFF	2005/05/20 12:53
<b>S3</b>	1898	(257/737).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/20 12:54
S4	25	("5007163"   "5391514").PN. OR ("5611481").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/20 15:21
S5	12	"liquid phase diffusion" and sn and alloy	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/20 15:22
S6	221	"liquid phase diffusion"	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/20 15:31

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S7	5626	diffusion adj bond\$3	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/20 15:31
S8	437	diffusion adj bond\$3 and sn	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/20 15:35
S9	768	diffusion adj bond\$3 and eutectic	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/20 15:35
S10	222	diffusion adj bond\$3 with eutectic	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/20 15:35
S12	77	bump with (align or alignment or self-align) and (resin with underfill)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/16 14:21
S13	1092	"flip chip" and self-align\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/16 14:23
S14	375	"flip chip" and self-align\$4 with (bump or ball or electrode)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/16 14:24

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S15	62	(US-20020132463-\$ or	US-PGPUB;	OR	ON	2006/12/13 16:39
		US-20020050404-\$ or	USPAT;			
		US-20010009297-\$ or	JPO;	ļ		
		US-20040178503-\$ or	DERWENT			
		US-20050011937-\$ or				
		US-20050104208-\$ or				
		US-20040004292-\$ or		Ì		
		US-20040113272-\$ or				
		US-20010013655-\$ or				
		US-20050093149-\$ or				
		US-20030173665-\$ or				
		US-20030230806-\$ or				
		US-20040169277-\$ or		ł l		
		US-20030150635-\$ or				
		US-20030022479-\$ or	•	1		
.		US-20010055146-\$ or				
		US-20040169286-\$).did. or		1		
		(US-5864178-\$ or US-6433425-\$ or				
		US-6740823-\$ or US-5878943-\$ or				
		US-6894389-\$ or US-5889326-\$ or				
		US-5930598-\$ or US-6335571-\$ or				
		US-6190940-\$ or US-5796591-\$ or				
		US-6011313-\$ or US-5611481-\$ or				
		US-6281581-\$ or US-5930597-\$ or				
		US-6333554-\$ or US-5641990-\$ or				
		US-6027957-\$ or US-5394490-\$ or				
		US-5773897-\$ or US-4764804-\$ or				
		US-6088236-\$ or US-6858111-\$ or				
		US-6198169-\$ or US-5672913-\$ or				,
		US-5461261-\$ or US-5249733-\$).		1		
		did. or (US-6130476-\$ or				
		US-6153940-\$ or US-6369451-\$ or				
		US-5629566-\$ or US-6507118-\$ or				
		US-6492197-\$ or US-4967950-\$ or				
		US-5734199-\$ or US-5421507-\$ or				
	•	US-6399426-\$ or US-5666008-\$ or				
		US-6002172-\$ or US-6249051-\$ or				
		US-5659203-\$).did. or				
		(JP-2000243785-\$ or				
		JP-10321671-\$).did. or				
		(JP-10321671-\$ or JP-08031835-\$				
		or JP-2000243785-\$).did.				

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S16	· 62	(US-20020132463-\$ or US-20020050404-\$ or US-20010009297-\$ or US-20040178503-\$ or US-20050011937-\$ or US-20050014208-\$ or US-20040004292-\$ or US-20040013272-\$ or US-20010013655-\$ or US-20030173665-\$ or US-20030173665-\$ or US-20030150635-\$ or US-20030150635-\$ or US-20030150635-\$ or US-20040169277-\$ or US-20030022479-\$ or US-20030022479-\$ or US-20040169286-\$).did. or (US-5864178-\$ or US-6433425-\$ or US-6740823-\$ or US-5889326-\$ or US-6894389-\$ or US-5889326-\$ or US-5930598-\$ or US-5930598-\$ or US-6335571-\$ or US-6190940-\$ or US-5796591-\$ or US-6011313-\$ or US-5611481-\$ or US-6281581-\$ or US-5611481-\$ or US-6281581-\$ or US-5641990-\$ or US-6027957-\$ or US-5441990-\$ or US-6773897-\$ or US-4764804-\$ or US-6088236-\$ or US-6858111-\$ or US-6198169-\$ or US-672913-\$ or US-6198169-\$ or US-672913-\$ or US-6153940-\$ or US-6369451-\$ or US-6492197-\$ or US-6369451-\$ or US-6492197-\$ or US-6369451-\$ or US-6399426-\$ or US-6507118-\$ or US-659203-\$).did. or (JP-10321671-\$).did.	US-PGPUB; USPAT; JPO; DERWENT	OR	ON	2006/06/28 17:50
S17	11	S16 and (modulus or elastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/28 17:50
S18	4	(("5346857") or ("4875617")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/12/13 16:42

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S19	5	(resin or underfill or epoxy) with "thermal shrinkage factor" and ("257".clas. or "438".clas.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/12/13 17:29
S20	78	(resin or underfill or epoxy or polymer) with "thermal shrinkage factor"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/12/13 16:46
S21	1258	(resin or underfill or epoxy) with shrink\$3 and ("257".clas. or "438". clas.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON ·	2006/12/13 17:30
S22	91	(underfill) with shrink\$3 and ("257". clas. or "438".clas.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/12/13 17:36
S23	1480	(epoxy or resin or polymer) with shrink\$3 and ("257".clas. or "438". clas.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/12/13 17:36
S24	<b>58</b>	(epoxy or resin or polymer) with shrink\$3 with (factor or percent or "%") and ("257".clas. or "438".clas.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/12/13 18:06
S25	2879	(epoxy or resin or polymer) with shrink\$3 with (factor or percent or "%")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2006/12/13 18:07
S26	1570	(epoxy or resin or polymer) with shrink\$3 with (percent or "%")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/12/13 18:09

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S27	30	(epoxy or resin or polymer) with shrink\$3 with (percent or "%") with thermosetting	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/12/13 18:09
S28	749	(epoxy or resin or polymer) with shrink\$3 with (percent or "%") with ("1" or "2" or "3" or "4")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/12/13 18:10
S29	168	(epoxy or resin or polymer) with shrink\$3 with (percent or "%") near ("1" or "2" or "3" or "4")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/12/13 18:10